



YOUSHANG SEMICONDUCTOR

**设计研发新型功率器件**

**各类小信号开关**

**中低压及高压大电流等场效应管**

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企业微信二维码



企业QQ二维码

## Product Summary

| BV <sub>DSS</sub> | R <sub>DS(ON)</sub> MAX       | I <sub>D</sub> MAX<br>T <sub>C</sub> = +25°C |
|-------------------|-------------------------------|--|
| 60V               | 8mΩ @ V <sub>GS</sub> = 10V   | 98A  |
|                   | 12mΩ @ V <sub>GS</sub> = 4.5V | 80A  |

## Features

- Rated to +175°C—Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching (UIS) Test in Production—Ensures More Reliable and Robust End Application
- Low R<sub>DS(ON)</sub>—Minimizes On-State Losses
- Low Input Capacitance
- Fast Switching Speed
- Wettable Flank for Improved Optical Inspection

## Description and Applications

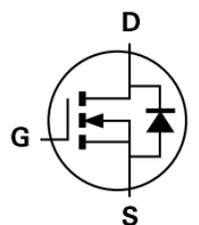
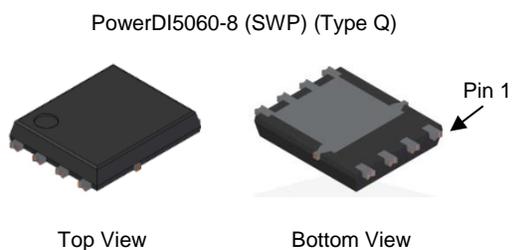
This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP, and is ideal for use in:

- Engine-management systems
- Body control electronics
- DC-DC converters

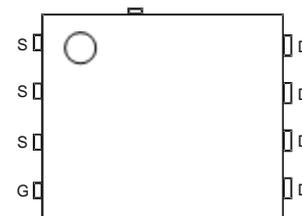
## Mechanical Data

- Package: PowerDI<sup>®</sup>5060-8
- Package Material: Molded Plastic, “Green” Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish—Matte Tin Annealed over Copper Leadframe; Solderable per MIL-STD-202, Method 208 (E3)
- Weight: 0.097 grams (Approximate)

Site 1:

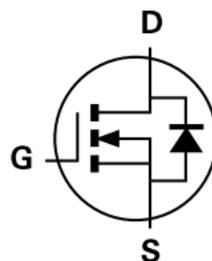
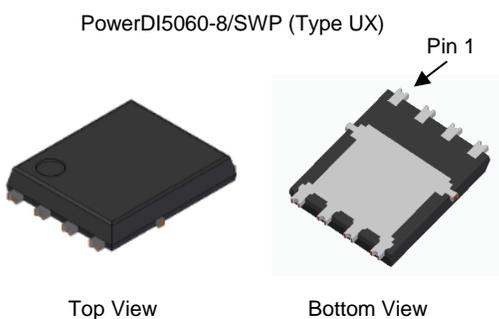


Internal Schematic

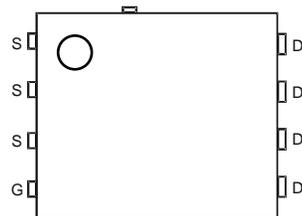


Top View  
Pin Configuration

Site 2:



Internal Schematic



Top View  
Pin Configuration

### Maximum Ratings (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

| Characteristic  | Symbol   | Value                      | Unit |
|---|----------|----------------------------|------|
| Drain-Source Voltage  | $V_{DS}$ | 60                         | V    |
| Gate-Source Voltage   | $V_{GS}$ | $\pm 20$                   | V    |
| Continuous Drain Current, $V_{GS} = 10\text{V}$ (Note 5)                    | $I_D$    | $T_A = +25^\circ\text{C}$  | 15.5 |
|   |          | $T_A = +100^\circ\text{C}$ | 11   |
| Continuous Drain Current, $V_{GS} = 10\text{V}$ (Note 6)                    | $I_D$    | $T_C = +25^\circ\text{C}$  | 98   |
|   |          | $T_C = +100^\circ\text{C}$ | 69   |
| Pulsed Drain Current (10 $\mu\text{s}$ Pulse, Duty Cycle = 1%)              | $I_{DM}$ | 392                        | A    |
| Maximum Continuous Body Diode Forward Current (Note 6)                      | $I_S$    | 98                         | A    |
| Pulsed Body Diode Forward Current (10 $\mu\text{s}$ Pulse, Duty Cycle = 1%) | $I_{SM}$ | 392                        | A    |
| Avalanche Current, $L = 0.1\text{mH}$                                       | $I_{AS}$ | 20                         | A    |
| Avalanche Energy, $L = 0.1\text{mH}$  | $E_{AS}$ | 20                         | mJ   |

### Thermal Characteristics

| Characteristic                                   | Symbol         | Value       | Unit             |
|--|----------------|-------------|------------------|
| Total Power Dissipation (Note 5)                 | $P_D$          | 2.9         | W                |
| Thermal Resistance, Junction to Ambient (Note 5) |                |             |                  |
| Total Power Dissipation (Note 6)                 | $P_D$          | 115         | W                |
| Thermal Resistance, Junction to Case (Note 6)    |                |             |                  |
| Operating and Storage Temperature Range          | $T_J, T_{STG}$ | -55 to +175 | $^\circ\text{C}$ |

Notes: 5. Device mounted on FR-4 substrate PCB, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.  
 6. Thermal resistance from junction to soldering point (on the exposed drain pad).

**Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic                             | Symbol              | Min | Typ  | Max  | Unit | Test Condition  |
|--|---------------------|-----|------|------|------|---|
| <b>OFF CHARACTERISTICS (Note 7)</b>        |                     |     |      |      |      |   |
| Drain-Source Breakdown Voltage             | BV <sub>DSS</sub>   | 60  | —    | —    | V    | V <sub>GS</sub> = 0V, I <sub>D</sub> = 1mA  |
| Zero Gate Voltage Drain Current            | I <sub>DSS</sub>    | —   | —    | 1    | μA   | V <sub>DS</sub> = 48V, V <sub>GS</sub> = 0V   |
| Gate-Source Leakage                        | I <sub>GSS</sub>    | —   | —    | ±100 | nA   | V <sub>GS</sub> = ±20V, V <sub>DS</sub> = 0V  |
| <b>ON CHARACTERISTICS (Note 7)</b>         |                     |     |      |      |      |   |
| Gate Threshold Voltage                     | V <sub>GS(TH)</sub> | 1   | —    | 3    | V    | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA                                |
| Static Drain-Source On-Resistance          | R <sub>DS(ON)</sub> | —   | 5.3  | 8    | mΩ   | V <sub>GS</sub> = 10V, I <sub>D</sub> = 20A   |
|  |                     | —   | 7.9  | 12   |      | V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 20A  |
| Diode Forward Voltage                      | V <sub>SD</sub>     | —   | 0.8  | 1.2  | V    | V <sub>GS</sub> = 0V, I <sub>S</sub> = 20A  |
| <b>DYNAMIC CHARACTERISTICS (Note 8)</b>    |                     |     |      |      |      |   |
| Input Capacitance                          | C <sub>iss</sub>    | —   | 2090 | —    | pF   | V <sub>DS</sub> = 30V, V <sub>GS</sub> = 0V<br>f = 1MHz                                   |
| Output Capacitance                         | C <sub>oss</sub>    | —   | 746  | —    |      |   |
| Reverse Transfer Capacitance               | C <sub>rss</sub>    | —   | 38.5 | —    |      |   |
| Gate Resistance                            | R <sub>g</sub>      | —   | 0.59 | —    | Ω    | V <sub>DS</sub> = 0V, V <sub>GS</sub> = 0V, f = 1MHz                                      |
| Total Gate Charge (V <sub>GS</sub> = 4.5V) | Q <sub>g</sub>      | —   | 19.3 | —    | nC   | V <sub>DS</sub> = 30V, I <sub>D</sub> = 20A   |
| Total Gate Charge (V <sub>GS</sub> = 10V)  | Q <sub>g</sub>      | —   | 41.3 | —    |      |   |
| Gate-Source Charge                         | Q <sub>gs</sub>     | —   | 6    | —    |      |   |
| Gate-Drain Charge                          | Q <sub>gd</sub>     | —   | 8.8  | —    |      |   |
| Turn-On Delay Time                         | t <sub>D(ON)</sub>  | —   | 5.7  | —    | ns   | V <sub>DD</sub> = 30V, V <sub>GS</sub> = 10V<br>I <sub>D</sub> = 20A, R <sub>g</sub> = 3Ω |
| Turn-On Rise Time                          | t <sub>r</sub>      | —   | 4.3  | —    |      |   |
| Turn-Off Delay Time                        | t <sub>D(OFF)</sub> | —   | 23.4 | —    |      |   |
| Turn-Off Fall Time                         | t <sub>f</sub>      | —   | 9.7  | —    |      |   |
| Body Diode Reverse Recovery Time           | t <sub>RR</sub>     | —   | 35.4 | —    | ns   | I <sub>F</sub> = 20A, di/dt = 100A/μs   |
| Body Diode Reverse Recovery Charge         | Q <sub>RR</sub>     | —   | 38.2 | —    | nC   |   |

Notes: 7. Short duration pulse test used to minimize self-heating effect.  
 8. Guaranteed by design. Not subject to product testing.

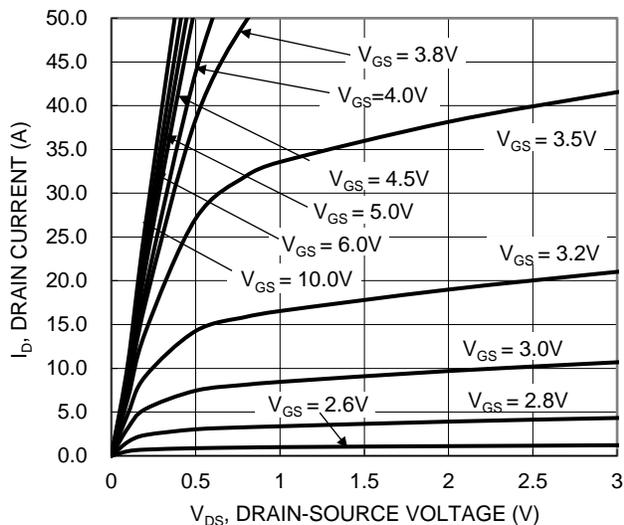


Figure 1. Typical Output Characteristic

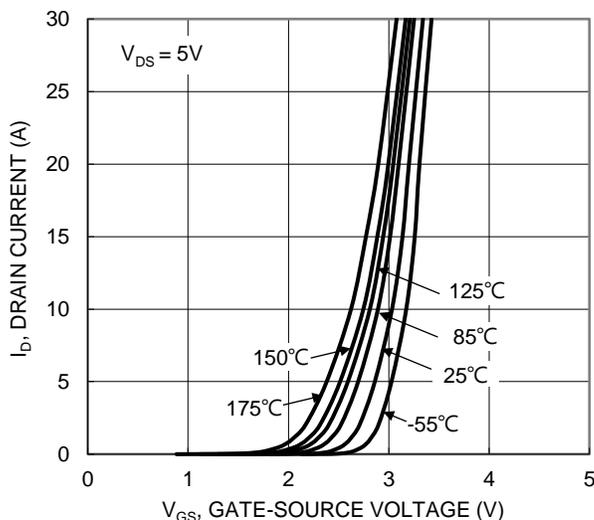


Figure 2. Typical Transfer Characteristic

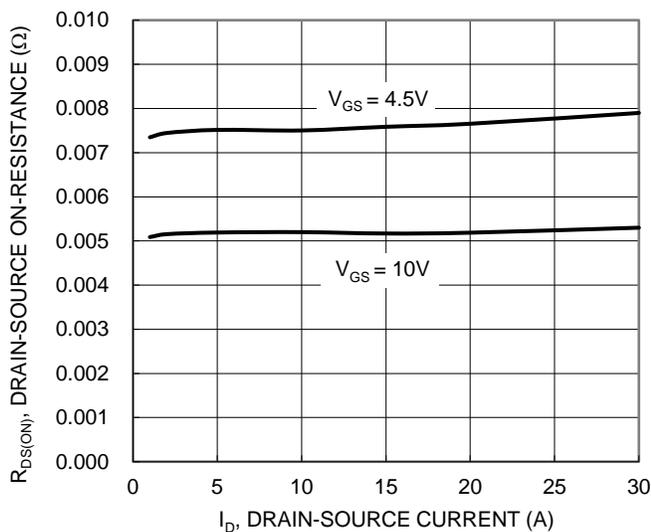


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

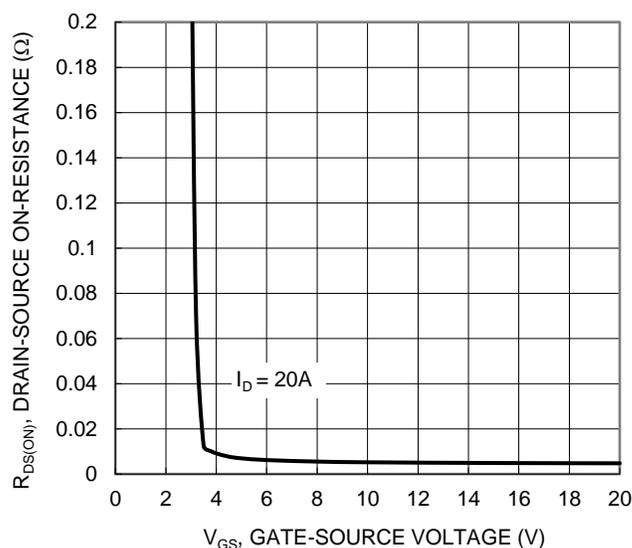


Figure 4. Typical Transfer Characteristic

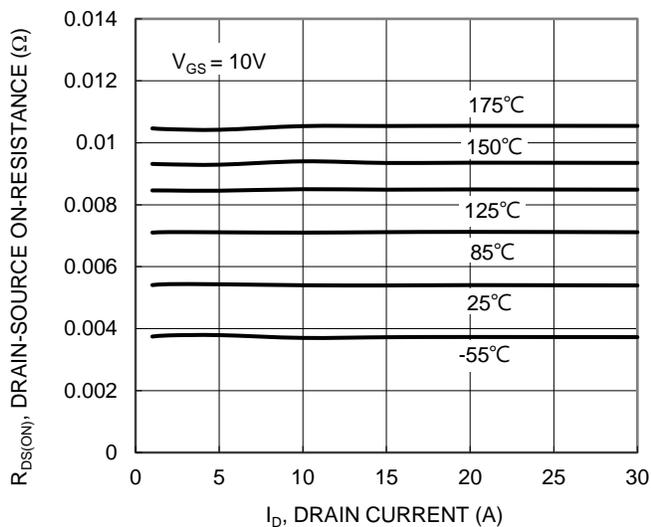


Figure 5. Typical On-Resistance vs. Drain Current and Temperature

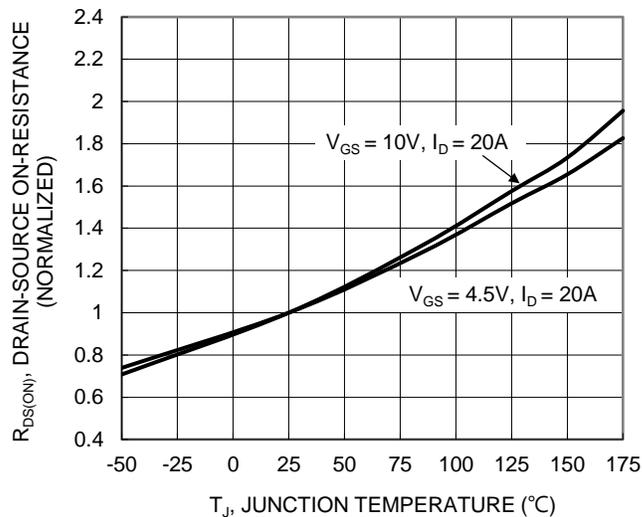


Figure 6. On-Resistance Variation with Temperature

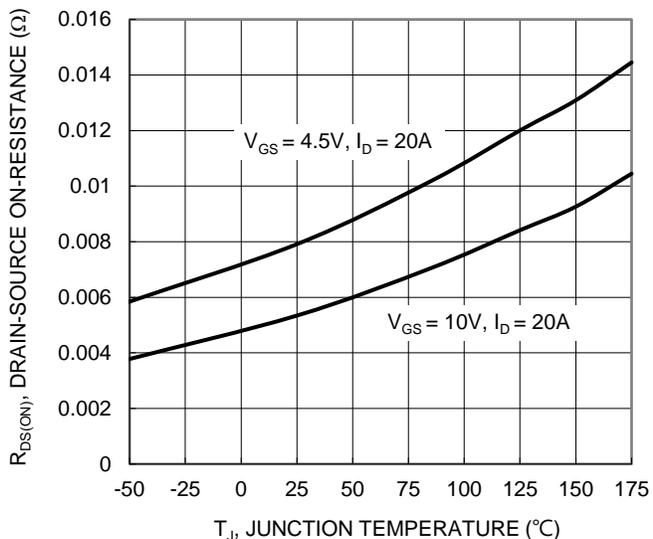


Figure 7. On-Resistance Variation with Temperature

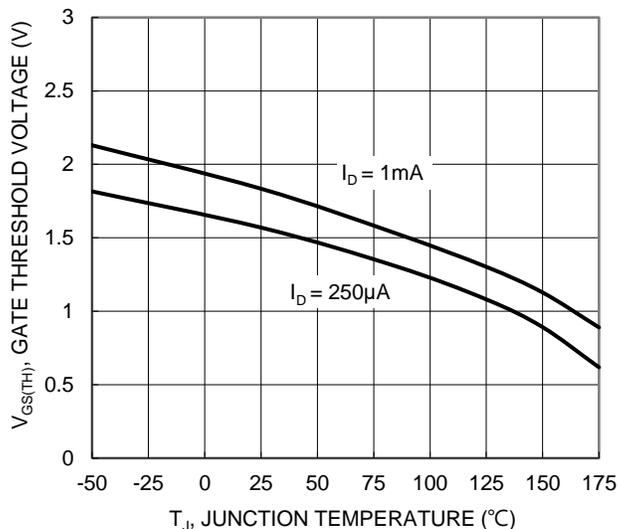


Figure 8. Gate Threshold Variation vs. Junction Temperature

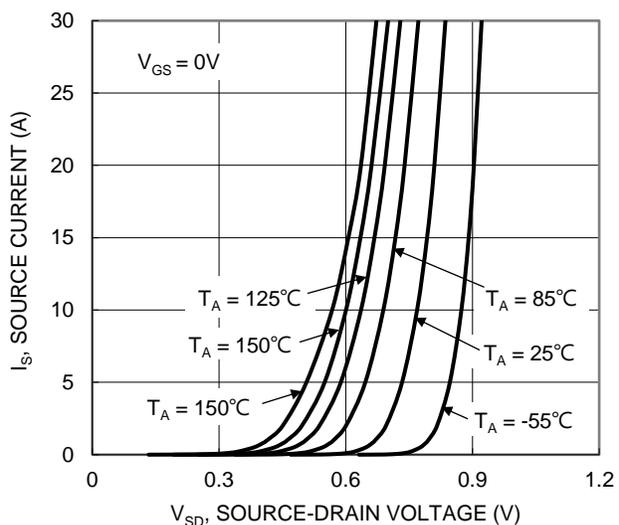


Figure 9. Diode Forward Voltage vs. Current

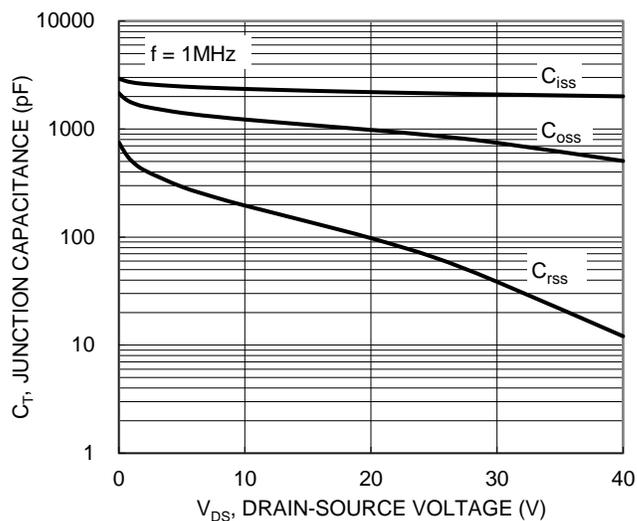


Figure 10. Typical Junction Capacitance

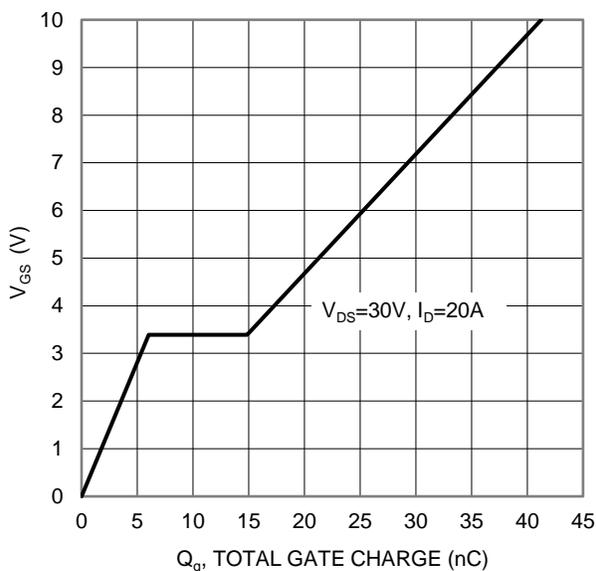


Figure 11. Gate Charge

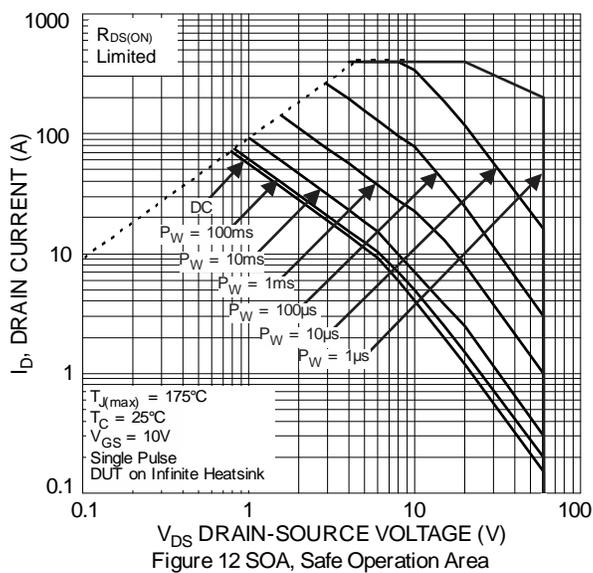


Figure 12 SOA, Safe Operation Area

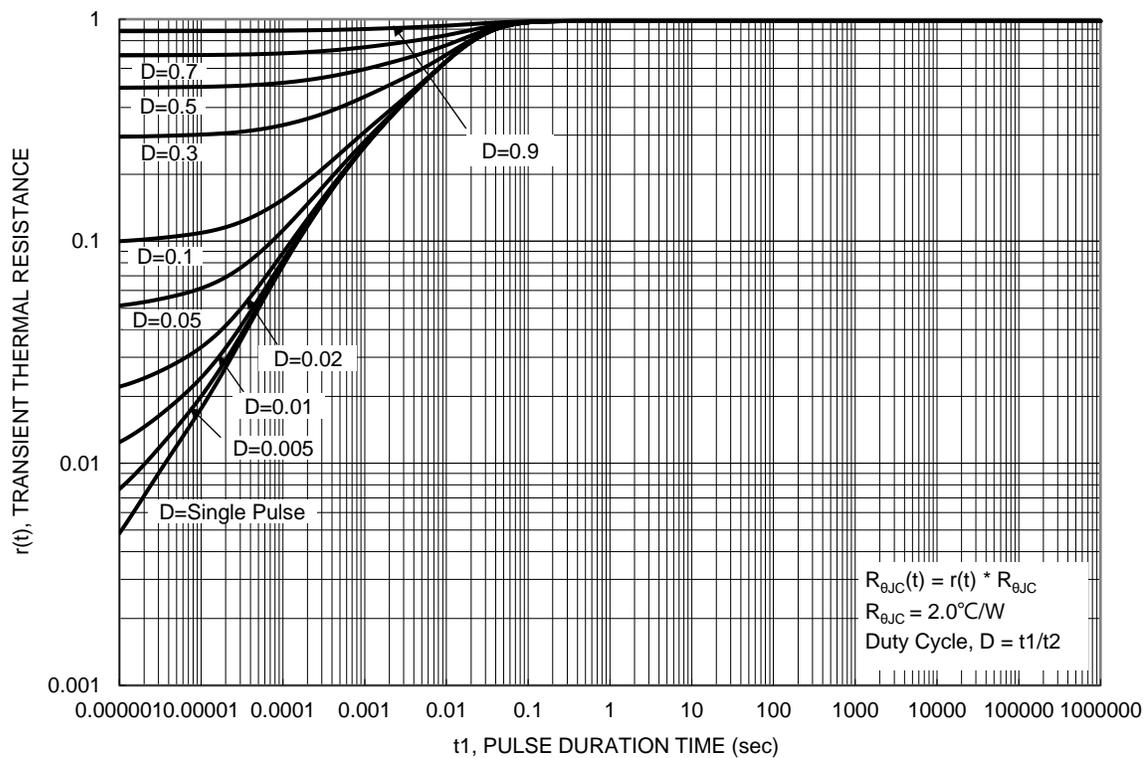
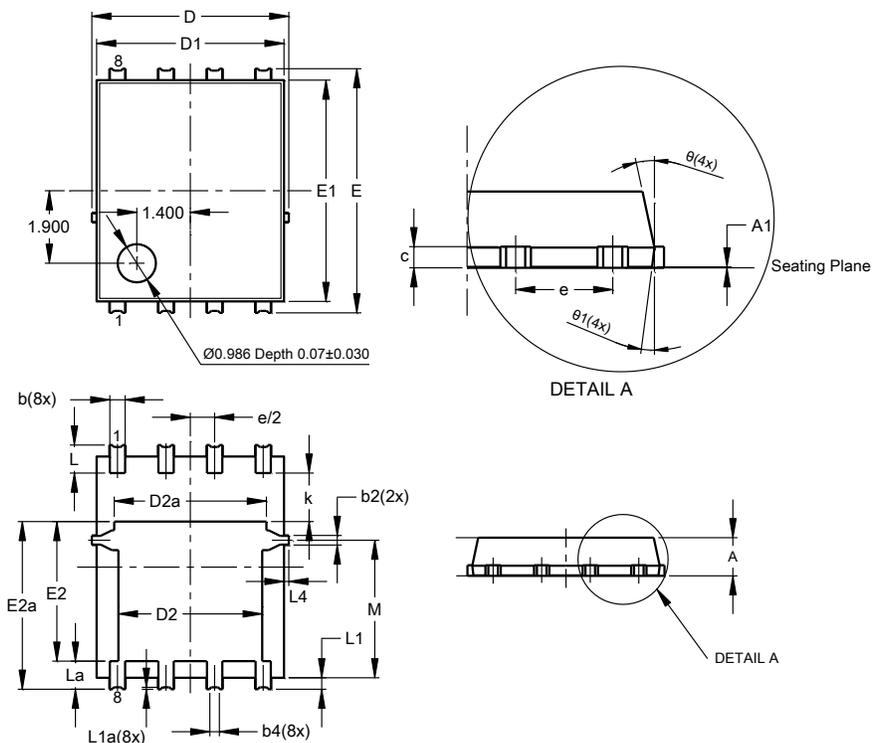


Figure 13. Transient Thermal Resistance

### Package Outline Dimensions

Site 1:

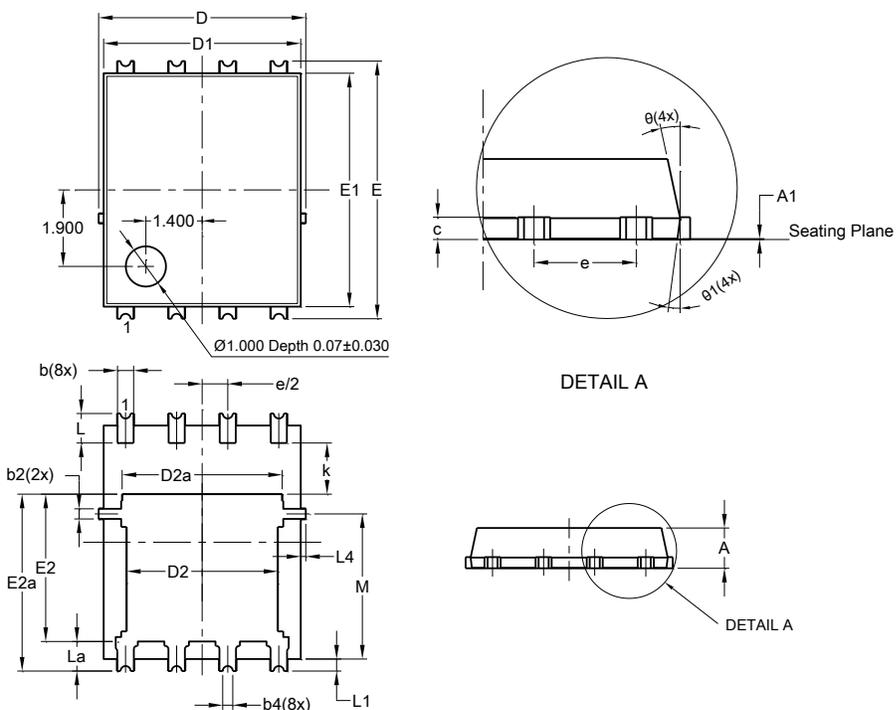
PowerDI5060-8 (SWP) (Type Q)



| PowerDI5060-8 (SWP)<br>(Type Q) |          |       |       |
|---------------------------------|----------|-------|-------|
| Dim                             | Min      | Max   | Typ   |
| A                               | 0.90     | 1.10  | 1.00  |
| A1                              | 0        | 0.05  | --    |
| b                               | 0.30     | 0.50  | 0.41  |
| b2                              | 0.20     | 0.35  | 0.25  |
| b4                              | 0.25REF  |       |       |
| c                               | 0.230    | 0.330 | 0.277 |
| D                               | 5.15 BSC |       |       |
| D1                              | 4.70     | 5.10  | 4.90  |
| D2                              | 3.56     | 3.96  | 3.76  |
| D2a                             | 3.78     | 4.18  | 3.98  |
| E                               | 6.40 BSC |       |       |
| E1                              | 5.60     | 6.00  | 5.80  |
| E2                              | 3.46     | 3.86  | 3.66  |
| E2a                             | 4.195    | 4.595 | 4.395 |
| e                               | 1.27BSC  |       |       |
| k                               | 1.05     | --    | --    |
| L                               | 0.635    | 0.835 | 0.735 |
| La                              | 0.635    | 0.835 | 0.735 |
| L1                              | 0.200    | 0.400 | 0.300 |
| L1a                             | 0.050REF |       |       |
| L4                              | 0.025    | 0.225 | 0.125 |
| M                               | 3.205    | 4.005 | 3.605 |
| $\theta$                        | 10°      | 12°   | 11°   |
| $\theta1$                       | 6°       | 8°    | 7°    |
| All Dimensions in mm            |          |       |       |

Site 2:

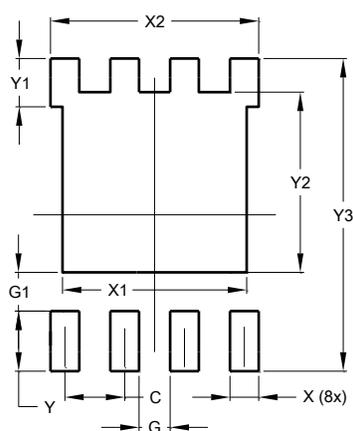
PowerDI5060-8/SWP (Type UX)



| PowerDI5060-8/SWP<br>(Type UX) |          |       |       |
|--------------------------------|----------|-------|-------|
| Dim                            | Min      | Max   | Typ   |
| A                              | 0.90     | 1.10  | 1.00  |
| A1                             | 0        | 0.05  | --    |
| b                              | 0.30     | 0.50  | 0.41  |
| b2                             | 0.20     | 0.35  | 0.25  |
| b4                             | 0.25REF  |       |       |
| c                              | 0.230    | 0.330 | 0.277 |
| D                              | 5.15 BSC |       |       |
| D1                             | 4.70     | 5.10  | 4.90  |
| D2                             | 3.56     | 3.96  | 3.76  |
| D2a                            | 3.78     | 4.18  | 3.98  |
| E                              | 6.40 BSC |       |       |
| E1                             | 5.60     | 6.00  | 5.80  |
| E2                             | 3.46     | 3.86  | 3.66  |
| E2a                            | 4.195    | 4.595 | 4.395 |
| e                              | 1.27BSC  |       |       |
| k                              | 1.05     | --    | --    |
| L                              | 0.635    | 0.835 | 0.735 |
| La                             | 0.635    | 0.835 | 0.735 |
| L1                             | 0.200    | 0.400 | 0.300 |
| L1a                            | 0.050REF |       |       |
| L4                             | 0.025    | 0.225 | 0.125 |
| M                              | 3.205    | 4.005 | 3.605 |
| $\theta$                       | 10°      | 12°   | 11°   |
| $\theta1$                      | 6°       | 8°    | 7°    |
| All Dimensions in mm           |          |       |       |

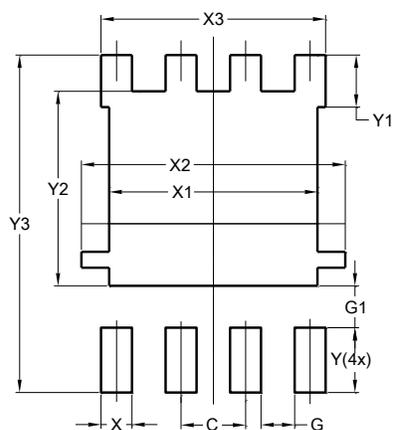
## Suggested Pad Layout

Site 1:

**PowerDI5060-8 (SWP) (Type Q)**


| Dimensions | Value (in mm) |
|------------|---------------|
| C          | 1.270         |
| G          | 0.660         |
| G1         | 0.820         |
| X          | 0.610         |
| X1         | 4.100         |
| X2         | 4.420         |
| Y          | 1.270         |
| Y1         | 1.020         |
| Y2         | 3.810         |
| Y3         | 6.610         |

Site 2:

**PowerDI5060-8/SWP (Type UX)**


| Dimensions | Value (in mm) |
|------------|---------------|
| C          | 1.270         |
| G          | 0.660         |
| G1         | 0.820         |
| X          | 0.610         |
| X1         | 4.100         |
| X2         | 5.190         |
| X3         | 4.420         |
| Y          | 1.270         |
| Y1         | 1.020         |
| Y2         | 3.810         |
| Y3         | 6.610         |